

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Maximum Drain voltage ⁽¹⁾	V _{D,MAX}	650	V
Drain Gate voltage (R _{GS} =1MΩ)	V _{DGR}	650	V
Gate-source (GND) voltage	V _{GS}	±30	V
Drain current pulsed ⁽²⁾	I _{DM}	36.0	ADC
Single pulsed avalanche energy ⁽³⁾	E _{AS}	950	mJ
Continuous drain current (T _C =25°C)	I _D	9.0	ADC
Continuous drain current (T _C =100°C)	I _D	5.8	ADC
Maximum Supply voltage	V _{CC,MAX}	30	V
Input voltage range	V _{FB}	−0.3 to V _{SD}	V
Total power dissipation	P _D	170	W
	Derating	1.33	W/°C
Operating ambient temperature	T _A	−25 to +85	°C
Storage temperature	T _{STG}	−55 to +150	°C

Notes:

1. T_j=25°C to 150°C
2. Repetitive rating: Pulse width limited by maximum junction temperature
3. L=20mH, V_{DD}=50V, R_G=27Ω, starting T_j=25°C

Electrical Characteristics (SFET part)

(Ta=25°C unless otherwise specified)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Drain source breakdown voltage	BV _{DSS}	V _{GS} =0V, I _D =50μA	650	-	-	V
Zero gate voltage drain current	I _{DSS}	V _{DS} =Max., Rating, V _{GS} =0V	-	-	50	μA
		V _{DS} =0.8Max., Rating, V _{GS} =0V, T _C =125°C	-	-	200	μA
Static drain source on resistance ^(note)	R _{DS(ON)}	V _{GS} =10V, I _D =4.5A	-	0.96	1.2	Ω
Forward transconductance ^(note)	g _{fs}	V _{DS} =15V, I _D =4.5A	5.0	-	-	S
Input capacitance	C _{iss}	V _{GS} =0V, V _{DS} =25V, f=1MHz	-	1750	-	pF
Output capacitance	C _{oss}		-	190	-	
Reverse transfer capacitance	C _{rss}		-	78	-	
Turn on delay time	t _{d(on)}	V _{DD} =0.5BV _{DSS} , I _D =9.0A (MOSFET switching time are essentially independent of operating temperature)	-	20	50	nS
Rise time	t _r		-	23	55	
Turn off delay time	t _{d(off)}		-	85	180	
Fall time	t _f		-	30	70	
Total gate charge (gate-source+gate-drain)	Q _g	V _{GS} =10V, I _D =9.0A, V _{DS} =0.5BV _{DSS} (MOSFET switching time are essentially independent of operating temperature)	-	74	75	nC
Gate source charge	Q _{gs}		-	12	-	
Gate drain (Miller) charge	Q _{gd}		-	35.4	-	

Note:

Pulse test: Pulse width ≤ 300μs, duty cycle ≤ 2%

$$S = \frac{1}{R}$$

Electrical Characteristics (CONTROL part)

(Ta=25°C unless otherwise specified)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
UVLO SECTION						
Start threshold voltage	VSTART	-	14	15	16	V
Stop threshold voltage	VSTOP	After turn on	9	10	11	V
OSCILLATOR SECTION						
Initial accuracy	FOSC	Ta=25°C	61	67	73	kHz
Frequency change with temperature ⁽²⁾	$\Delta F/\Delta T$	-25°C ≤ Ta ≤ +85°C	-	±5	±10	%
Maximum duty cycle	Dmax	-	74	77	80	%
FEEDBACK SECTION						
Feedback source current	IFB	Ta=25°C, 0V ≤ Vfb ≤ 3V	0.7	0.9	1.1	mA
Shutdown Feedback voltage	VSD	-	6.9	7.5	8.1	V
Shutdown delay current	Idelay	Ta=25°C, 5V ≤ Vfb ≤ VSD	4.0	5.0	6.0	μA
SOFT START SECTION						
Soft Start Voltage	VSS	VFB =2V	4.7	5.0	5.3	V
Soft Start Current	ISS	Sync & S/S=GND	0.8	1.0	1.2	mA
REFERENCE SECTION						
Output voltage ⁽¹⁾	Vref	Ta=25°C	4.80	5.00	5.20	V
Temperature Stability ⁽¹⁾⁽²⁾	Vref/ΔT	-25°C ≤ Ta ≤ +85°C	-	0.3	0.6	mV/°C
CURRENT LIMIT (SELF-PROTECTION) SECTION						
Peak Current Limit	I _{OVER}	Max. inductor current	5.28	6.00	6.72	A
PROTECTION SECTION						
Thermal shutdown temperature (Tj) ⁽¹⁾	TSD	-	140	160	-	°C
Over voltage protection voltage	VOVP	-	23	25	28	V
TOTAL DEVICE SECTION						
Start Up current	ISTART	VCC=14V	0.1	0.3	0.4	mA
Operating supply current (control part only)	I _{OP}	Ta=25°C	6	12	18	mA
VCC zener voltage	VZ	I _{CC} =20mA	30	32.5	35	V

Notes:

1. These parameters, although guaranteed, are not 100% tested in production
2. These parameters, although guaranteed, are tested in EDS (wafer test) process
3. The amplitude of the sync. pulse is recommended to be between 2V and 3V for stable sync. function.

Typical Performance Characteristics

(These characteristic graphs are normalized at $T_a=25^{\circ}\text{C}$)

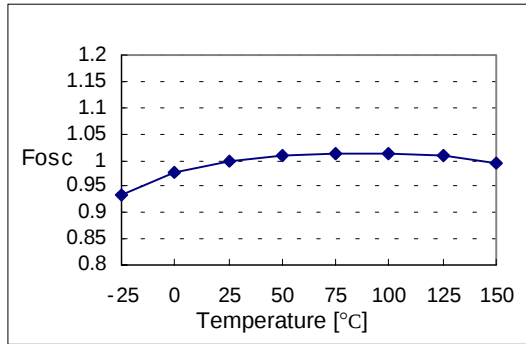


Figure 1. Operating Frequency

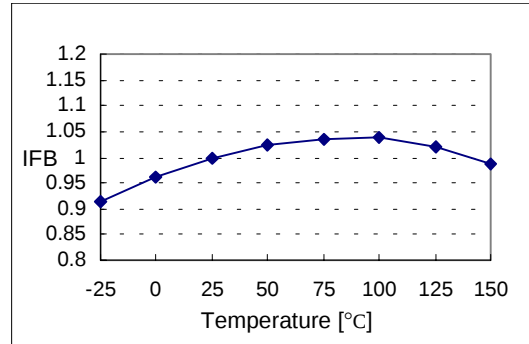


Figure 2. Feedback Source Current

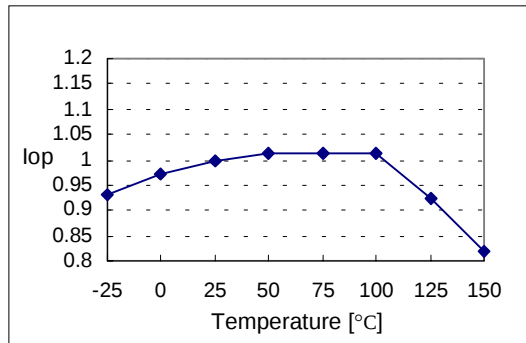


Figure 3. Operating Supply Current

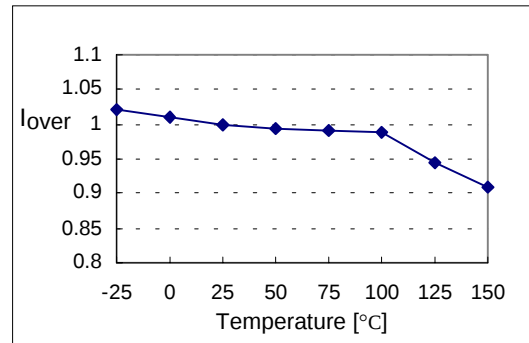


Figure 4. Peak Current Limit

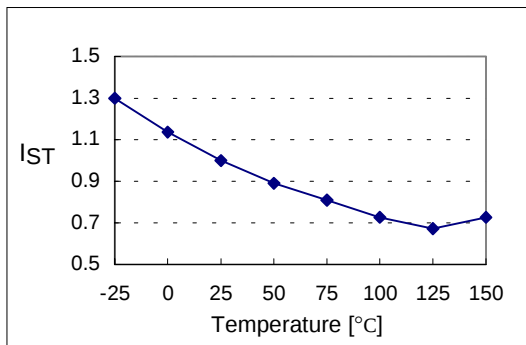


Figure 5. Start up Current

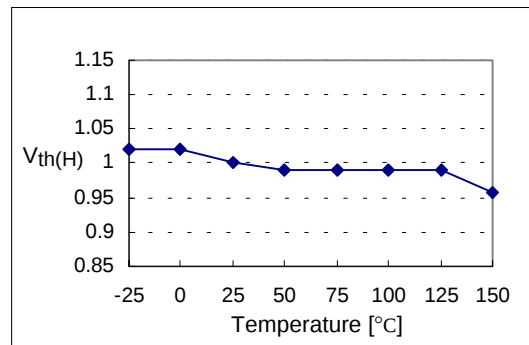


Figure 6. Start Threshold Voltage

Typical Performance Characteristics (Continued)

(These characteristic graphs are normalized at $T_a=25^{\circ}\text{C}$)

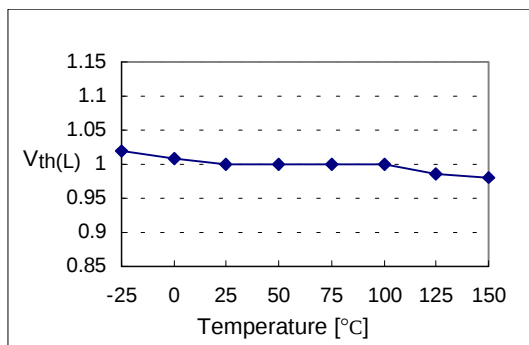


Figure 7. Stop Threshold Voltage

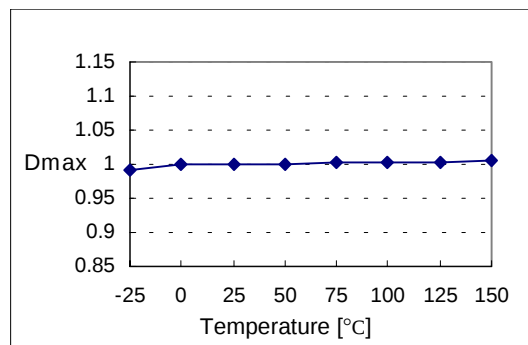


Figure 8. Maximum Duty Cycle

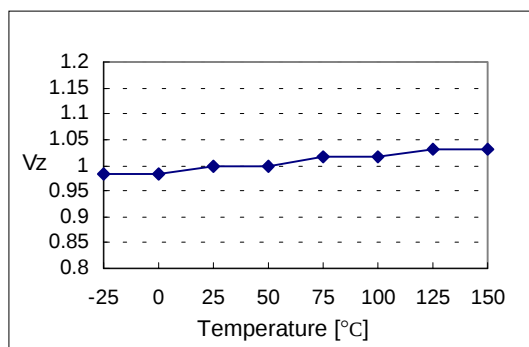


Figure 9. VCC Zener Voltage

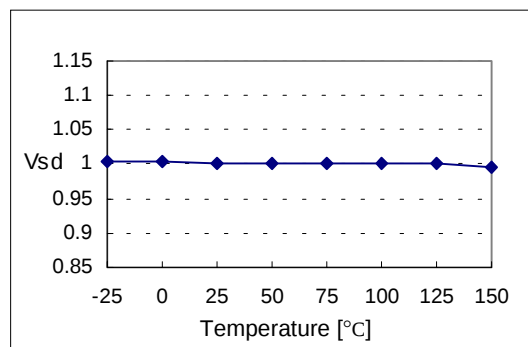


Figure 10. Shutdown Feedback Voltage

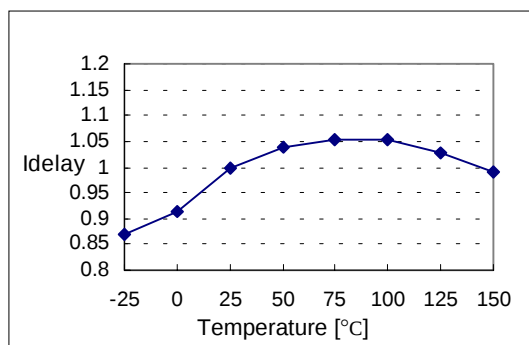


Figure 11. Shutdown Delay Current

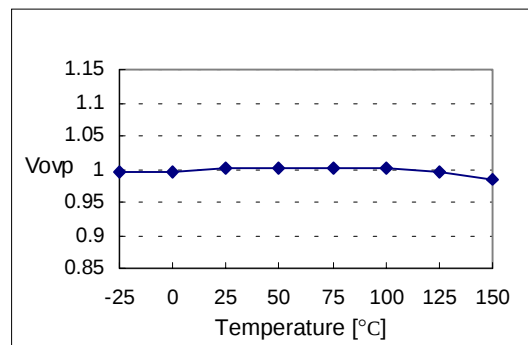


Figure 12. Over Voltage Protection

Typical Performance Characteristics (Continued)

(These characteristic graphs are normalized at $T_a=25^\circ\text{C}$)

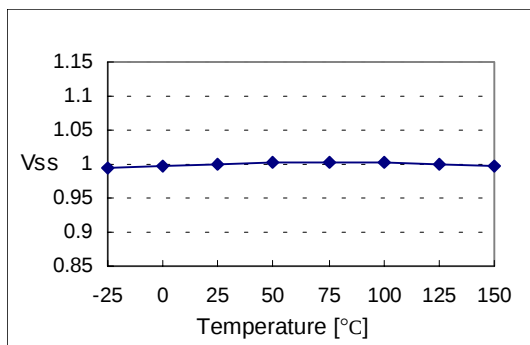


Figure 13. Soft Start Voltage

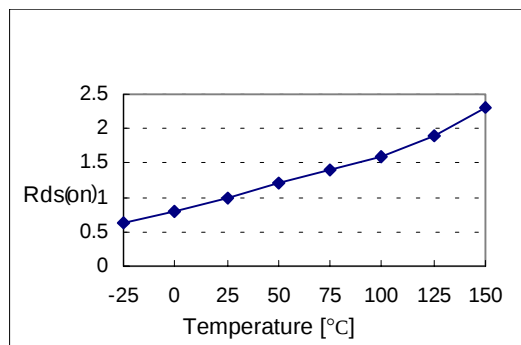


Figure 14. Static Drain Source on Resistance

Technical drawing of a mechanical part showing three views: front, side, and top. The drawing includes dimensions and tolerances in millimeters.

Front View Dimensions:

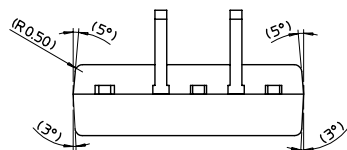
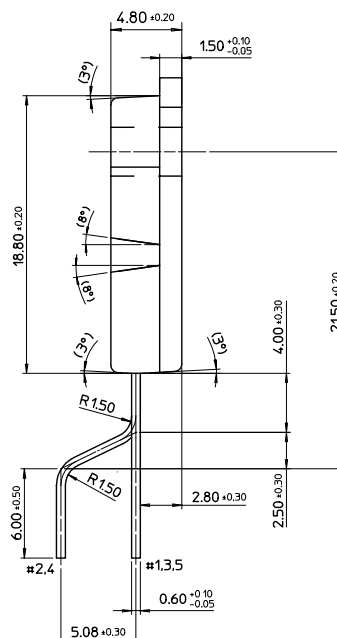
- Overall width: 15.60 ± 0.20
- Top width: (13.60)
- Inner width: (9.60)
- Bottom width: (8.00)
- Top thickness: $\phi 3.30 \pm 0.20$
- Central circular feature diameter: $\phi 3.30 \pm 0.20$
- Top thickness: (3.80)
- Top thickness: 5.00 ± 0.20
- Top thickness: (7.00)
- Top thickness: (12.76)
- Top thickness: (20.00)
- Top thickness: 23.50 ± 0.20
- Top thickness: (13.95)
- Top thickness: 1.30 ± 0.20
- Top thickness: $4 - 1.10 \pm 0.20$
- Top thickness: $5 - 0.80 \pm 0.20$
- Top thickness: 3.50 ± 0.20
- Top thickness: 16.50 ± 0.30
- Top thickness: (2.135)
- Top thickness: 3.81 TYP
- Top thickness: $[3.81 \pm 0.30]$
- Top thickness: $3 - 2.54 \text{ TYP}$
- Top thickness: $[3 - 2.54 \pm 0.30]$

Side View Dimensions:

- Overall height: 18.80 ± 0.20
- Top thickness: 4.80 ± 0.20
- Top thickness: 1.50 ± 0.10
- Top thickness: 0.60 ± 0.10
- Top thickness: 2.80 ± 0.30
- Top thickness: (1.40)
- Top thickness: (3°)
- Top thickness: (8°)
- Top thickness: (3°)
- Top thickness: (3°)

Top View Dimensions:

- Overall width: 15.60 ± 0.20
- Top width: (13.60)
- Inner width: (9.60)
- Bottom width: (8.00)
- Top thickness: $\phi 3.30 \pm 0.20$
- Top thickness: (3.80)
- Top thickness: 5.00 ± 0.20
- Top thickness: (7.00)
- Top thickness: (12.76)
- Top thickness: (20.00)
- Top thickness: 23.50 ± 0.20
- Top thickness: (13.95)
- Top thickness: 1.30 ± 0.20
- Top thickness: $4 - 1.10 \pm 0.20$
- Top thickness: $5 - 0.80 \pm 0.20$
- Top thickness: 3.50 ± 0.20
- Top thickness: 16.50 ± 0.30
- Top thickness: (2.135)
- Top thickness: 3.81 TYP
- Top thickness: $[3.81 \pm 0.30]$
- Top thickness: $3 - 2.54 \text{ TYP}$
- Top thickness: $[3 - 2.54 \pm 0.30]$

[illegible]

Ordering Information

Product Number	Package	Rating	Operating Temperature
KA1M0965R-TU	TO-3P-5L	650V, 9A	-25°C to +85°C
KA1M0965R-YDTU	TO-3P-5L(Forming)		

TU : Non Forming Type

YDTU : Forming Type

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